

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S3	1	2003-212104.NRAN.	DERWENT	OR	ON	2005/11/11 16:21
S2	1	WO-2002101806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 16:22
S4	2	DE-19847101-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 16:23
S6	1	("5527392").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/11 16:40
S7	15	("4047496" "4654509" "4938940" "4996942" "5033407" "5044943" "5068871" "5108792" "5182093" "5188058" "5314540").PN. OR ("5527392"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 16:41
S8	2	WO-9801890-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 16:53
S5	1	("6316361").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/11 16:54
S10	1	("5879576").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/11 16:56
S9	1	("6461439").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/11 16:56

S11	25	("3854443" "3947236" "4495024" "4560590" "4574093" "4575408" "4662918" "4662987" "4903717" "4903754" "4958061" "5318801" "5356476" "5431700" "5447431" "5520538" "5542559" "5772770" "5778968" "5881208" "5927077" "5937541" "5960159" "6099056" "6183565").PN. OR ("6461439"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 17:02
S12	29	(34/433).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 17:54
S15	42	S14 not S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 17:55
S14	46	(34/508).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 17:55
S13	279	(34/428).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 17:56
S16	290	(34/443).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 17:57
S17	276	S13 not S12 not S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:02

S19	174	aixtron.as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:05
S18	287	S16 not S13 not S12 not S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:05
S20	4	("4232063" "4925388" "5903711" "6402849").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 18:13
S22	2680	(118/725).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 18:14
S21	1253	(118/58).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 18:14
S24	340	S23 and thermal adj conductivit\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:16
S23	3916	S21 S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:16
S25	80	S23 and thermal adj conductivit\$3 with gas	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 18:17
S29	26	("4457359" "4512391" "4909314" "4969511" "5113929").PN. OR ("5181556"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 18:42

S31	485248	(156/345.\$).CCLS. or ("118") or ("34") or ("216") or ("427") or ("438")).CLAS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/11 19:24
S30	86	S23 and thermal\$3 adj (conductivit\$3 conduct\$5) same gas not S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 19:24
S26	127	S23 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 19:24
S32	1263	S31 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 19:25
S34	2	("6679951" "6843201").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 19:37
S33	1136	S31 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas not S26 not S30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/11 19:37

S36	27	US-3947236-\$.DID. OR US-4860687-\$.DID. OR US-4495024-\$.DID. OR US-4560590-\$.DID. OR US-4575408-\$.DID. OR US-0975561-\$.DID. OR US-5178639-\$.DID. OR US-5180273-\$.DID. OR US-5314848-\$.DID. OR US-5332442-\$.DID. OR US-5407449-\$.DID. OR US-5414244-\$.DID. OR US-5430271-\$.DID. OR US-5431700-\$.DID. OR US-5646313-\$.DID. OR US-5650082-\$.DID. OR US-5790750-\$.DID. OR US-5855681-\$.DID. OR US-5997588-\$.DID. OR US-6001175-\$.DID. OR US-6018616-\$.DID. OR US-6064799-\$.DID. OR US-6072163-\$.DID. OR US-6080969-\$.DID. OR US-6097005-\$.DID. OR US-6099056-\$.DID.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 19:44
S35	14	("4058430" "4860687" "5382333" "5711811" "5731634" "5865365" "5939334" "6006763" "6033584" "6066892" "6108937" "6124189" "6130123" "6136163").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/11 19:44
S37	14	("4058430" "4860687" "5382333" "5711811" "5731634" "5865365" "5939334" "6006763" "6033584" "6066892" "6108937" "6124189" "6130123" "6136163").PN. OR ("6679951").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/12 12:43
S38	4	DE-410873-\$.did. EP-469470-\$. did. EP-880168-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:48
S39	2	GB-2340508-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:49

S40	6	WO-9310652-\$.did. WO-9801890-\$.did. WO-9917343-\$.did. WO-0003420-\$.did. WO-0150502-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:55
S46	485248	(156/345.\$).CCLS. or (("118") or ("34") or ("216") or ("427") or ("438")).CLAS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/12 12:56
S45	86	S43 and thermal\$3 adj (conductivit\$3 conduct\$5) same gas not S44	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:56
S44	127	S43 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:56
S43	3916	S41 S42	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:56
S42	2680	(118/725).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/12 12:56
S41	1253	(118/58).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/12 12:56
S48	3386	(rapid adj thermal rtp (heat\$3 thermal\$3) adj (treat\$3 process\$3)).ti,ab,clm. and (gas) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3)) not S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 12:58

S49	634	(rapid adj thermal rtp (heat\$3 thermal\$3) adj (treat\$3 process\$3)).ti,ab,clm. and ((gas) with (mix\$4)) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3)) not S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:00
S51	12	("5374564" "5403406" "5738909" "5856027" "5966625" "6171965" "6403450" "6573159" "6577386" "6589609" "6680260" "6809015").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/12 13:04
S50	149	(rapid adj thermal rtp (heat\$3 thermal\$3) adj (treat\$3 process\$3)).ti,ab,clm. and (substrate wafer semiconductor workpiece work adj piece).ti,ab,clm. and ((gas) with (mix\$4)) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3)) not S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:05
S55	22	S54 and (side face)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:07
S52	39	(rapid adj thermal rtp (heat\$3 thermal\$3) adj (treat\$3 process\$3)) and (substrate wafer semiconductor workpiece work adj piece) and ((gas) and (mix\$4)) and ((heat\$3 thermal\$3) near2 (conduct\$5 conductivit\$3))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:07
S56	163	S54 not S55	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:09
S54	185	S53 not S52	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:09
S53	206	(heat\$3 cool\$3 thermal\$3) near5 (substrate wafer semiconductor workpiece work adj piece) and ((gas) and (mix\$4)) and ((heat\$3 thermal\$3) near2 (conduct\$5 conductivit\$3))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 13:13
S57	1338	(heat\$3 cool\$3 thermal\$3) with (substrate wafer semiconductor workpiece work adj piece) and ((gas) with (mix\$4)) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3))	US-PGPUB; USPAT	OR	ON	2005/11/12 13:14
S60	1	"6849241".pn.	US-PGPUB; USPAT	OR	ON	2005/11/12 13:25

S61	3	("5595606" "5871586" "5976261").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/12 13:26
S58	271	(heat\$3 cool\$3 thermal\$3) with (substrate wafer semiconductor workpiece work adj piece) with (side face) and ((gas) with (mix\$4)) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3))	US-PGPUB; USPAT	OR	ON	2005/11/12 14:08
S62	397	(heat\$3 cool\$3 thermal\$3) with (substrate wafer semiconductor workpiece work adj piece) with (side face surface) and ((gas) with (mix\$4)) same ((heat\$3 thermal\$3) with (conduct\$5 conductivit\$3)) not S58 not S47 not S50	US-PGPUB; USPAT	OR	ON	2005/11/12 14:09
S59	222	S58 not S47 not S50	US-PGPUB; USPAT	OR	ON	2005/11/12 14:09
S64	2	JP-07335630-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/12 14:19
S65	21	(gerhard near2 strauch).in.	US-PGPUB; USPAT	OR	ON	2005/11/12 14:48
S63	513	S57 not S58 not S47 not S50 not S62	US-PGPUB; USPAT	OR	ON	2005/11/12 14:48
L4	2	("6679951").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/13 19:28
L5	2	US-6679951-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 19:35
L8	1	2002-147553.NRAN.	DERWENT	OR	ON	2005/11/13 19:36
L7	1	WO-200188972-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 19:40
L10	1	2002-216264.NRAN.	DERWENT	OR	ON	2005/11/13 19:41

L9	1	WO-200150502-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 19:43
L11	2	WO-9801890-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 19:45
L14	1	2003-212104.NRAN.	DERWENT	OR	ON	2005/11/13 19:46
L13	1	WO-2002101806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 19:46
L16	22	("3854443" "3947236" "4495024" "4560590" "4574093" "4575408" "4622918" "4662987" "4903717" "4958061" "5318801" "5356476" "5431700" "5447431" "5520536" "5542559" "5772770" "5778968" "5881208" "5927077" "5937541" "5960159").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/13 19:52
L17	24	("5318801").URPN.	USPAT	OR	ON	2005/11/13 20:00
L19	13	("4738748" "4860687" "5178639" "5180273" "5407449" "5411076" "5431700" "5464313" "5855681" "6097005" "6111225" "6183565" "6215106").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/13 20:01
L18	1	"6770851".pn.	USPAT	OR	ON	2005/11/13 20:01
L22	2	JP-61294812-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 20:06
L24	2	JP-63136532-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 20:07

L23	2	JP-62021237-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 20:07
L26	2	JP-04078130-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 20:08
L25	2	JP-02034915-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 20:08
L27	17	(US-20030056720-\$ or US-20030131495-\$).did. or (US-4512391-\$ or US-4979466-\$ or US-5181556-\$ or US-5318801-\$ or US-5527392-\$ or US-5997588-\$ or US-6183565-\$ or US-6316361-\$ or US-6408537-\$ or US-6461439-\$ or US-6679951-\$ or US-6803546-\$ or US-6849241-\$).did. or (JP-07335630-\$).did. or (WO-2002101806-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/11/13 21:14
L29	420	(rapid adj thermal adj processing rtp).ti,ab,clm. and (glass metal) with (substrate)	US-PGPUB; USPAT	OR	ON	2005/11/13 21:19
L28	9	27 and (glass metal)	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2005/11/13 21:19
L30	71	(rapid adj thermal adj processing rtp).ti,ab,clm. and (glass) with (substrate) and (metal) with (substrate)	US-PGPUB; USPAT	OR	ON	2005/11/13 21:20
L31	18	("4421987" "5155336" "5206871" "5635409" "5660472" "5716133" "5993059" "6007241" "6027244" "6054687" "6124912" "6127658" "6142663" "6160242" "6174080" "6183130" "6215106" "6641302").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/13 21:25

S28	13	("4818327" "5181556" "5238499" "5620525" "5624499" "5660472" "5711815" "5906684" "5960555" "6035100" "6046439" "6054688" "6215106").PN. OR ("6803546"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/13 21:40
L32	3643	((427/248.1) or (427/255.23)). CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/13 21:40
S47	1136	S46 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas not S44 not S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 21:41
L38	49	32 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas not L36 not L37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 21:41
L37	86	L35 and thermal\$3 adj (conductivit\$3 conduct\$5) same gas not L36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 21:41
L36	127	L35 and thermal\$3 adj (conductivit\$3 conduct\$5) with gas	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 21:41
L35	3916	L33 L34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/13 21:41
L34	2680	(118/725).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/13 21:41

L33	1253	(118/58).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/13 21:41
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